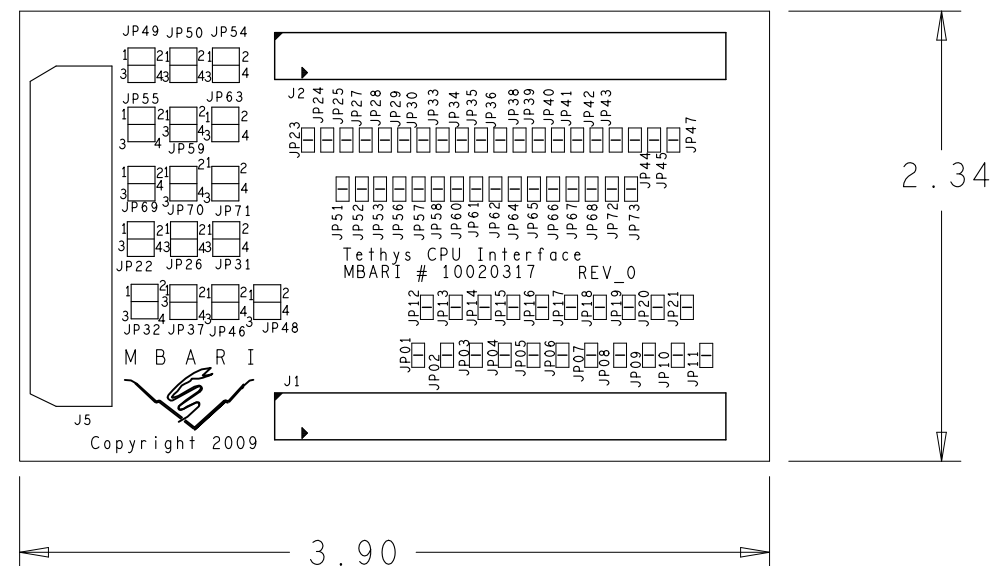


1. MATERIAL: COPPER WEIGHT SHALL BE 1oz ON ALL LAYERS.
OVERALL BOARD THICKNESS TO 0.062" +/- 0.007"
2. UNLESS OTHERWISE SPECIFIED ALL HOLE DIMENSIONS APPLY
AFTER PLATING.
3. ALL HOLES SHALL BE LOCATED WITHIN 0.003" DIAMETER OF
TRUE POSITION. LAYER TO LAYER REGISTRATION SHALL BE
WITHIN 0.003".
4. CONDUCTOR WIDTHS AND SPACING SHALL BE WITHIN +/-001"
OF ARTWORK ORIGINALS.
5. APPLY SOLDERMASK OVER BARE COPPER. COLOR: BLACK.
6. WARP OR TWIST OF BOARD SHALL NOT EXCEED 0.010 INCH
PER INCH.
7. SILKSCREEN BOTH TOP AND BOTTOM COMPONENT SIDES WITH
WHITE EPOXY INK.
8. REMOVE ALL BURRS.
9. CUT OUTSIDE OF 0.001" BOARD OUTLINE.



REVISIONS			
REV	DESCRIPTION	DATE	APPROVED

UNLESS OTHERWISE SPECIFIED	SIGNATURES	DATE	TETHYS CPU INTERFACE BOARD			
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS +/- 0.02" 3 PL DECIMALS +/- 0.005" ANGLES +/- 1 Degree FRACTIONS +			MONTEREY BAY AQUARIUM RESEARCH INSTITUTE			
			7700 SANDHOLDT ROAD			
			MOSS LANDING, CA			
			SIZE B	REVISION 0-1	DWG NO 10020317	
	DESIGNED BY: engineer	SCALE 1 - 1			SHEET 1 - 1	
	LAYOUT BY: JOSE ROSAL					